



**NSAI**  
Standards

Irish Standard  
I.S. EN 60603-7-4:2010

Connectors for electronic equipment --  
Part 7-4: Detail specification for 8-way,  
unshielded, free and fixed connectors,  
for data transmissions with frequencies  
up to 250 MHz (IEC 60603-7-4:2010  
(EQV))

## I.S. EN 60603-7-4:2010

*Incorporating amendments/corrigenda issued since publication:*

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S.R. xxx: Standard Recommendation - recommendation based on the consensus of an expert panel and subject to public consultation.

SWiFT xxx: A rapidly developed recommendatory document based on the consensus of the participants of an NSAI workshop.

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EUROPEAN STANDARD  
NORME EUROPÉENNE  
EUROPÄISCHE NORM

**EN 60603-7-4**

July 2010

ICS 31.220.10

Supersedes EN 60603-7-4:2005

English version

**Connectors for electronic equipment -  
Part 7-4: Detail specification for 8-way, unshielded, free and fixed  
connectors, for data transmissions with frequencies up to 250 MHz  
(IEC 60603-7-4:2010)**

Connecteurs pour équipements  
électroniques -  
Partie 7-4: Spécification particulière  
pour les fiches et les embases  
non blindées à 8 voies pour la  
transmission de données  
à des fréquences jusqu'à 250 MHz  
(CEI 60603-7-4:2010)

Steckverbinder für elektronische  
Einrichtungen -  
Teil 7-4: Bauartspezifikation  
für ungeschirmte freie und feste  
Steckverbinder, 8polig,  
für Datenübertragungen bis 250 MHz  
(IEC 60603-7-4:2010)

This European Standard was approved by CENELEC on 2010-07-01. CENELEC members are bound to comply with the CEN/CENELEC Internal Regulations which stipulate the conditions for giving this European Standard the status of a national standard without any alteration.

Up-to-date lists and bibliographical references concerning such national standards may be obtained on application to the Central Secretariat or to any CENELEC member.

This European Standard exists in three official versions (English, French, German). A version in any other language made by translation under the responsibility of a CENELEC member into its own language and notified to the Central Secretariat has the same status as the official versions.

CENELEC members are the national electrotechnical committees of Austria, Belgium, Bulgaria, Croatia, Cyprus, the Czech Republic, Denmark, Estonia, Finland, France, Germany, Greece, Hungary, Iceland, Ireland, Italy, Latvia, Lithuania, Luxembourg, Malta, the Netherlands, Norway, Poland, Portugal, Romania, Slovakia, Slovenia, Spain, Sweden, Switzerland and the United Kingdom.

**CENELEC**

European Committee for Electrotechnical Standardization  
Comité Européen de Normalisation Electrotechnique  
Europäisches Komitee für Elektrotechnische Normung

**Management Centre: Avenue Marnix 17, B - 1000 Brussels**

## **Foreword**

The text of document 48B/2137/FDIS, future edition 2 of IEC 60603-7-4, prepared by SC 48B, Connectors, of IEC TC 48, Electromechanical components and mechanical structures for electronic equipment, was submitted to the IEC-CENELEC parallel vote and was approved by CENELEC as EN 60603-7-4 on 2010-07-01.

This European Standard supersedes EN 60603-7-4:2005.

The main technical changes with regard to EN 60603-7-4:2005 are as follows:

- Removal of test methods that are now referenced to EN 60512-26-100.
- Addition of TCL and TCTL requirements.
- Removal of the electrical, mechanical, dimensional, environmental conditioning tests by reference to EN 60603-7.

Attention is drawn to the possibility that some of the elements of this document may be the subject of patent rights. CEN and CENELEC shall not be held responsible for identifying any or all such patent rights.

The following dates were fixed:

- |                                                                                                                                                |       |            |
|------------------------------------------------------------------------------------------------------------------------------------------------|-------|------------|
| – latest date by which the EN has to be implemented<br>at national level by publication of an identical<br>national standard or by endorsement | (dop) | 2011-04-01 |
| – latest date by which the national standards conflicting<br>with the EN have to be withdrawn                                                  | (dow) | 2013-07-01 |

Annex ZA has been added by CENELEC.

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## **Endorsement notice**

The text of the International Standard IEC 60603-7-4:2010 was approved by CENELEC as a European Standard without any modification.

In the official version, for Bibliography, the following note has to be added for the standard indicated:

IEC 60512-26-100:2008	NOTE	Harmonized as EN 60512-26-100:2008 (not modified).
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## Annex ZA (normative)

### Normative references to international publications with their corresponding European publications

The following referenced documents are indispensable for the application of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE When an international publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

<u>Publication</u>	<u>Year</u>	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
IEC 60512-1-100	-	Connectors for electronic equipment - Tests and measurements - Part 1-100: General - Applicable publications	EN 60512-1-100	-
IEC 60512-2-1	-	Connectors for electronic equipment - Tests and measurements - Part 2-1: Electrical continuity and contact resistance tests - Test 2a: Contact resistance - Millivolt level method	EN 60512-2-1	-
IEC 60512-27-100	201X <sup>1)</sup>	Connectors for electronic equipment - Tests and measurements - Part 27-100: Signal integrity tests up to 500 MHz on IEC 60603-7 series connectors - Tests 27a to 27g	EN 60512-27-100	201X <sup>2)</sup>
IEC 60603-7	2008	Connectors for electronic equipment - Part 7: Detail specification for 8-way, unshielded, free and fixed connectors	EN 60603-7	2009
IEC 61156	Series	Multicore and symmetrical pair/quad cables for digital communications	-	-
IEC 62153-4-12	2009	Metallic communication cable test methods - Part 4-12: Electromagnetic compatibility (EMC) - Coupling attenuation or screening attenuation of connecting hardware - Absorbing clamp method	-	-

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<sup>1)</sup> To be published.

<sup>2)</sup> At draft stage.

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## INTERNATIONAL ELECTROTECHNICAL COMMISSION

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### CONNECTORS FOR ELECTRONIC EQUIPMENT –

#### **Partie 7-4: Detail specification for 8-way, unshielded, free and fixed connectors, for data transmission with frequencies up to 250 MHz**

### FOREWORD

- 1) The International Electrotechnical Commission (IEC) is a worldwide organization for standardization comprising all national electrotechnical committees (IEC National Committees). The object of IEC is to promote international co-operation on all questions concerning standardization in the electrical and electronic fields. To this end and in addition to other activities, IEC publishes International Standards, Technical Specifications, Technical Reports, Publicly Available Specifications (PAS) and Guides (hereafter referred to as "IEC Publication(s)"). Their preparation is entrusted to technical committees; any IEC National Committee interested in the subject dealt with may participate in this preparatory work. International, governmental and non-governmental organizations liaising with the IEC also participate in this preparation. IEC collaborates closely with the International Organization for Standardization (ISO) in accordance with conditions determined by agreement between the two organizations.
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- 9) Attention is drawn to the possibility that some of the elements of this IEC Publication may be the subject of patent rights. IEC shall not be held responsible for identifying any or all such patent rights.

International Standard IEC 60603-7-4 has been prepared by subcommittee 48B: Connectors, of IEC technical committee 48: Electromechanical components and mechanical structures for electronic equipment.

This second edition of IEC 60603-7-4 cancels and replaces the first edition issued in 2005, and constitutes a technical revision.

The main technical changes with regard to the previous edition are as follows:

- Removal of test methods that are now referenced to IEC 60512-26-100.
- Addition of TCL and TCTL requirements.
- Removal of the electrical, mechanical, dimensional, environmental conditioning tests by reference to IEC 60603-7.

The text of this standard is based on the following documents:

FDIS	Report on voting
48B/2137/FDIS	48B/2178/RVD

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

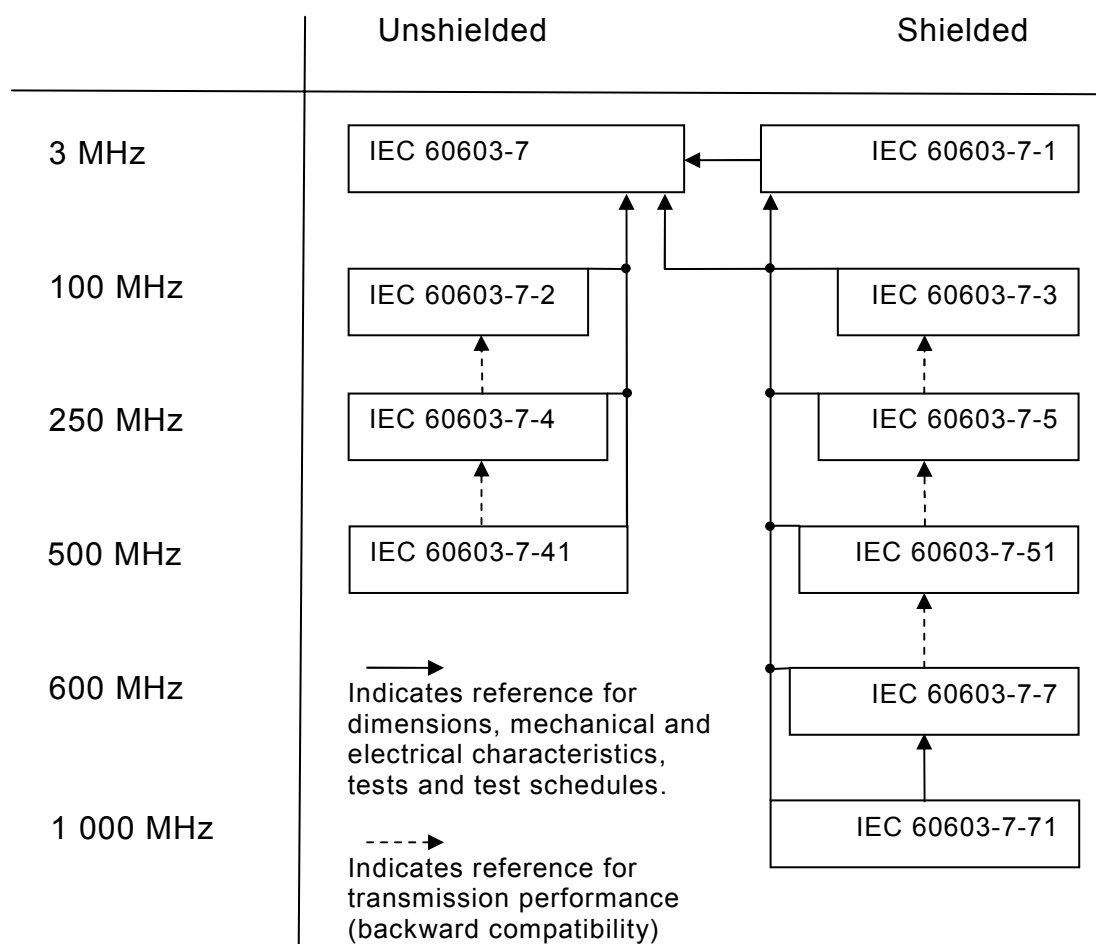
A list of all parts of IEC 60603 series, under the general title *Connectors for electronic equipment*, can be found on the IEC website.

The committee has decided that the contents of this publication will remain unchanged until the stability date indicated on the IEC web site under "<http://webstore.iec.ch>" in the data related to the specific publication. At this date, the publication will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

## INTRODUCTION

IEC 60603-7 is the base specification of the whole series. Subsequent specifications do not duplicate information given in the base document, but list only additional requirements. For complete specification regarding a component of a higher number document all lower numbered documents shall be considered as well. The following diagram shows the interrelation of the documents:



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